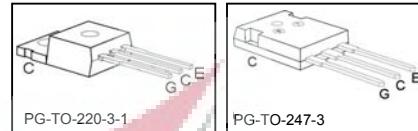
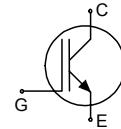


Fast IGBT in NPT-technology

- 75% lower E_{off} compared to previous generation combined with low conduction losses
- Short circuit withstand time – 10 μs
- Designed for:
 - Motor controls
 - Inverter
- NPT-Technology for 600V applications offers:
 - very tight parameter distribution
 - high ruggedness, temperature stable behaviour
 - parallel switching capability
- Qualified according to JEDEC¹ for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <http://www.infineon.com/igbt/>



| Type | V_{CE} | I_C | $V_{CE(\text{sat})}$ | T_j | Marking | Package |
|----------|----------|-------|----------------------|-------|---------|---------------|
| SGP30N60 | 600V | 30A | 2.5V | 150°C | G30N60 | PG-T0-220-3-1 |
| SGW30N60 | 600V | 30A | 2.5V | 150°C | G30N60 | PG-T0-247-3 |

Maximum Ratings

| Parameter | Symbol | Value | Unit |
|--|--------------------|------------|------------------|
| Collector-emitter voltage | V_{CE} | 600 | V |
| DC collector current | I_C | | A |
| $T_C = 25^\circ\text{C}$ | | 41 | |
| $T_C = 100^\circ\text{C}$ | | 30 | |
| Pulsed collector current, t_p limited by $T_{j\text{max}}$ | $I_{C\text{puls}}$ | 112 | |
| Turn off safe operating area | - | 112 | |
| $V_{CE} \leq 600\text{V}, T_j \leq 150^\circ\text{C}$ | | | |
| Gate-emitter voltage | V_{GE} | ± 20 | V |
| Avalanche energy, single pulse | E_{AS} | 165 | mJ |
| $I_C = 30\text{ A}, V_{CC} = 50\text{ V}, R_{GE} = 25\Omega$, start at $T_j = 25^\circ\text{C}$ | | | |
| Short circuit withstand time ² | t_{SC} | 10 | μs |
| $V_{GE} = 15\text{V}, V_{CC} \leq 600\text{V}, T_j \leq 150^\circ\text{C}$ | | | |
| Power dissipation | P_{tot} | 250 | W |
| $T_C = 25^\circ\text{C}$ | | | |
| Operating junction and storage temperature | T_j, T_{stg} | -55...+150 | $^\circ\text{C}$ |
| Soldering temperature, wavesoldering, 1.6mm (0.063 in.) from case for 10s | T_s | 260 | |

¹ J-STD-020 and JESD-022

² Allowed number of short circuits: <1000; time between short circuits: >1s.

Thermal Resistance

| Parameter | Symbol | Conditions | Max. Value | Unit |
|---|------------|---------------------------------|------------|------|
| Characteristic | | | | |
| IGBT thermal resistance, junction – case | R_{thJC} | | 0.5 | K/W |
| Thermal resistance, junction – ambient | R_{thJA} | PG-T0-220-3-1 PG-T0-247-3-21 | 62 40 | |

Electrical Characteristic, at $T_j = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value | | | Unit |
|---|----------------------|---|-------|------------|------------|---------------|
| | | | min. | Typ. | max. | |
| Static Characteristic | | | | | | |
| Collector-emitter breakdown voltage | $V_{(BR)CES}$ | $V_{GE}=0\text{V}, I_C=500\mu\text{A}$ | 600 | - | - | V |
| Collector-emitter saturation voltage | $V_{CE(\text{sat})}$ | $V_{GE} = 15\text{V}, I_C=30\text{A}$ $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$ | 1.7 | 2.1 2.5 | 2.4 3.0 | |
| Gate-emitter threshold voltage | $V_{GE(\text{th})}$ | $I_C=700\mu\text{A}, V_{CE}=V_{GE}$ | 3 | 4 | 5 | |
| Zero gate voltage collector current | I_{CES} | $V_{CE}=600\text{V}, V_{GE}=0\text{V}$ $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$ | - | - | 40 3000 | μA |
| Gate-emitter leakage current | I_{GES} | $V_{CE}=0\text{V}, V_{GE}=20\text{V}$ | - | - | 100 | nA |
| Transconductance | g_{fs} | $V_{CE}=20\text{V}, I_C=30\text{A}$ | - | 20 | - | S |
| Dynamic Characteristic | | | | | | |
| Input capacitance | C_{iss} | $V_{CE}=25\text{V},$ $V_{GE}=0\text{V},$ $f=1\text{MHz}$ | - | 1600 | 1920 | pF |
| Output capacitance | C_{oss} | | - | 150 | 180 | |
| Reverse transfer capacitance | C_{rss} | | - | 92 | 110 | |
| Gate charge | Q_{Gate} | $V_{CC}=480\text{V}, I_C=30\text{A}$ $V_{GE}=15\text{V}$ | - | 140 | 182 | nC |
| Internal emitter inductance measured 5mm (0.197 in.) from case | L_E | PG-T0-220-3-1 PG-T0-247-3-21 | - | 7 13 | - | nH |
| Short circuit collector current ²⁾ | $I_{C(\text{SC})}$ | $V_{GE}=15\text{V}, t_{\text{SC}} \leq 10\mu\text{s}$ $V_{CC} \leq 600\text{V},$ $T_j \leq 150^\circ\text{C}$ | - | 300 | - | A |

²⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



SGP30N60
SGW30N60

Switching Characteristic, Inductive Load, at $T_j=25\text{ }^\circ\text{C}$

| Parameter | Symbol | Conditions | Value | | | Unit |
|----------------------------|--------------|--|-------|------|------|------|
| | | | min. | typ. | max. | |
| IGBT Characteristic | | | | | | |
| Turn-on delay time | $t_{d(on)}$ | $T_j=25\text{ }^\circ\text{C}$, $V_{CC}=400\text{V}$, $I_C=30\text{A}$, $V_{GE}=0/15\text{V}$, $R_G=11\Omega$, $L_\sigma^{(1)}=180\text{nH}$, $C_\sigma^{(1)}=900\text{pF}$ Energy losses include "tail" and diode reverse recovery. | - | 44 | 53 | ns |
| Rise time | t_r | | - | 34 | 40 | |
| Turn-off delay time | $t_{d(off)}$ | | - | 291 | 349 | |
| Fall time | t_f | | - | 58 | 70 | |
| Turn-on energy | E_{on} | | - | 0.64 | 0.77 | mJ |
| Turn-off energy | E_{off} | | - | 0.65 | 0.85 | |
| Total switching energy | E_{ts} | | - | 1.29 | 1.62 | |

Switching Characteristic, Inductive Load, at $T_j=150\text{ }^\circ\text{C}$

| Parameter | Symbol | Conditions | Value | | | Unit |
|----------------------------|--------------|---|-------|------|------|------|
| | | | min. | typ. | max. | |
| IGBT Characteristic | | | | | | |
| Turn-on delay time | $t_{d(on)}$ | $T_j=150\text{ }^\circ\text{C}$, $V_{CC}=400\text{V}$, $I_C=30\text{A}$, $V_{GE}=0/15\text{V}$, $R_G=11\Omega$, $L_\sigma^{(1)}=180\text{nH}$, $C_\sigma^{(1)}=900\text{pF}$ Energy losses include "tail" and diode reverse recovery. | - | 44 | 53 | ns |
| Rise time | t_r | | - | 34 | 40 | |
| Turn-off delay time | $t_{d(off)}$ | | - | 324 | 389 | |
| Fall time | t_f | | - | 67 | 80 | |
| Turn-on energy | E_{on} | | - | 0.98 | 1.18 | mJ |
| Turn-off energy | E_{off} | | - | 0.92 | 1.19 | |
| Total switching energy | E_{ts} | | - | 1.90 | 2.38 | |

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¹⁾ Leakage inductance L_σ and Stray capacity C_σ due to dynamic test circuit in Figure E.

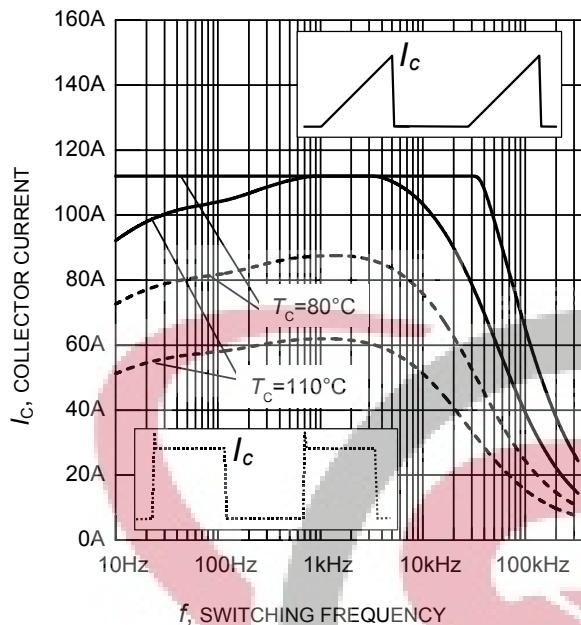


Figure 1. Collector current as a function of switching frequency

($T_j \leq 150^\circ\text{C}$, $D = 0.5$, $V_{CE} = 400\text{V}$,
 $V_{GE} = 0/+15\text{V}$, $R_G = 11\Omega$)

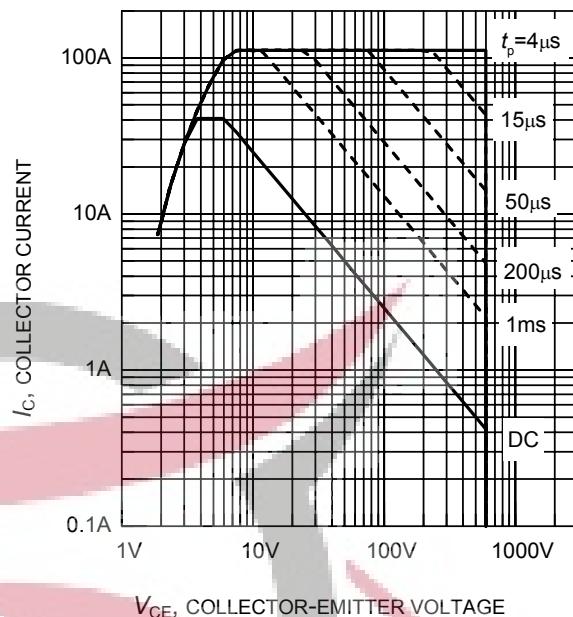


Figure 2. Safe operating area

($D = 0$, $T_C = 25^\circ\text{C}$, $T_j \leq 150^\circ\text{C}$)

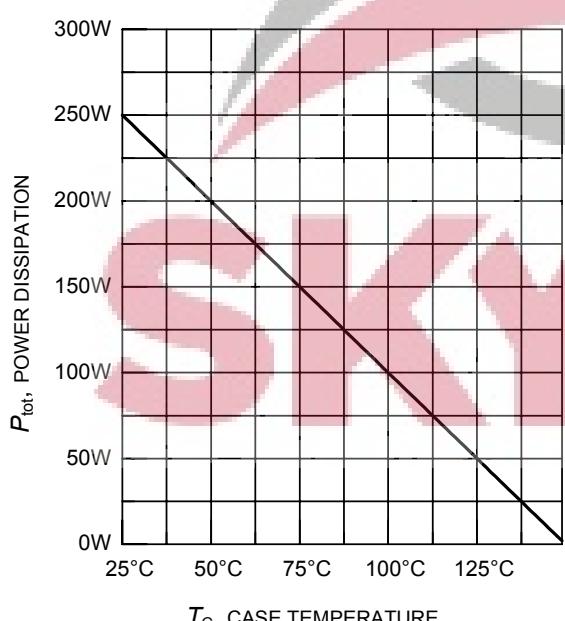


Figure 3. Power dissipation as a function of case temperature

($T_j \leq 150^\circ\text{C}$)

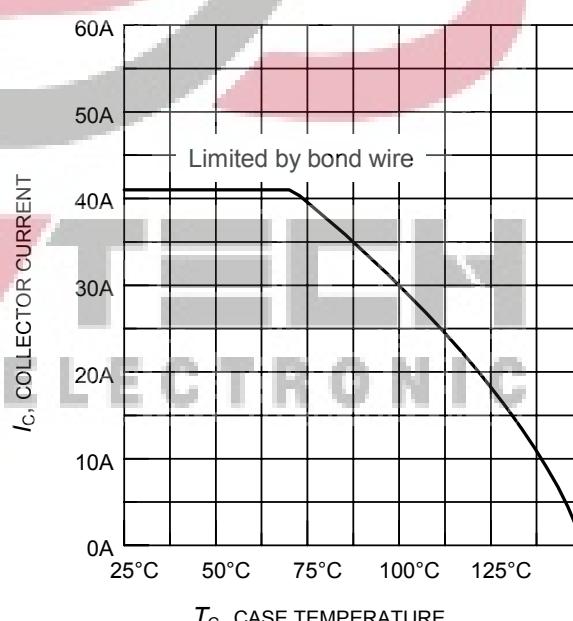


Figure 4. Collector current as a function of case temperature

($V_{GE} \leq 15\text{V}$, $T_j \leq 150^\circ\text{C}$)

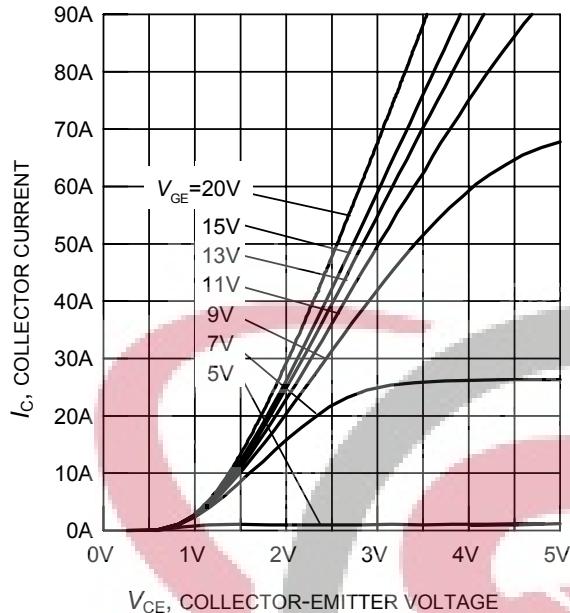


Figure 5. Typical output characteristics
($T_j = 25^\circ\text{C}$)

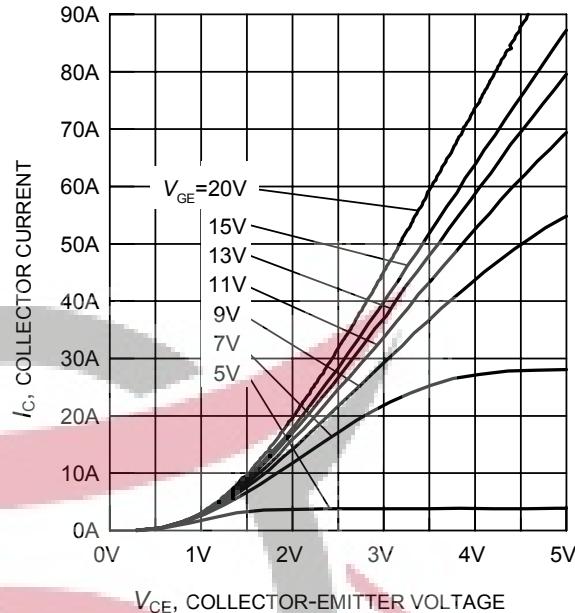


Figure 6. Typical output characteristics
($T_j = 150^\circ\text{C}$)

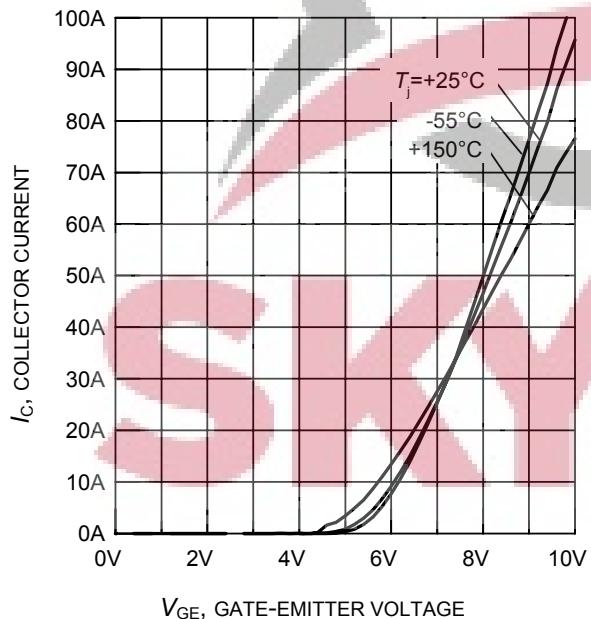


Figure 7. Typical transfer characteristics
($V_{CE} = 10\text{V}$)

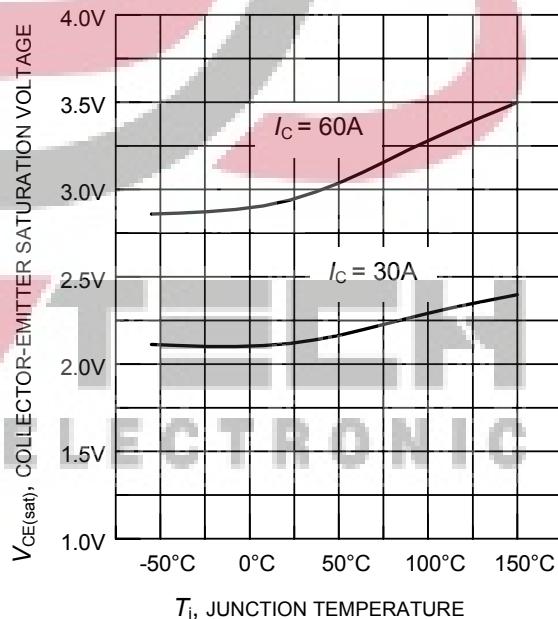
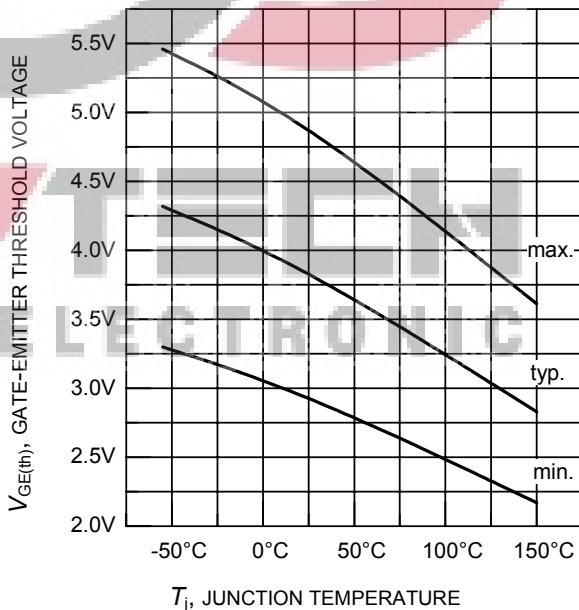
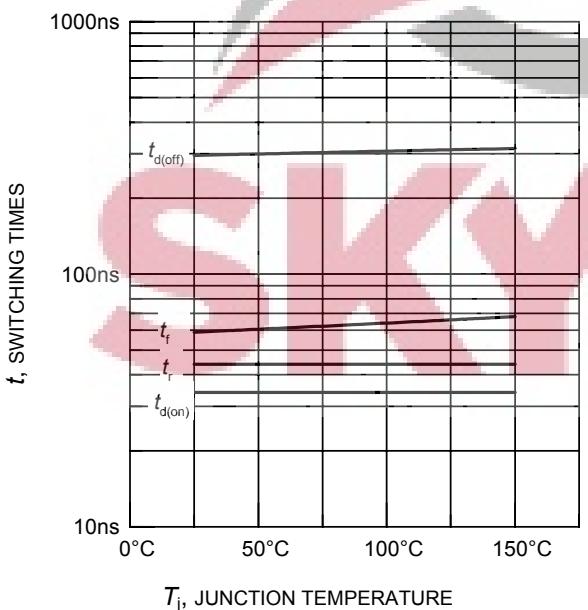
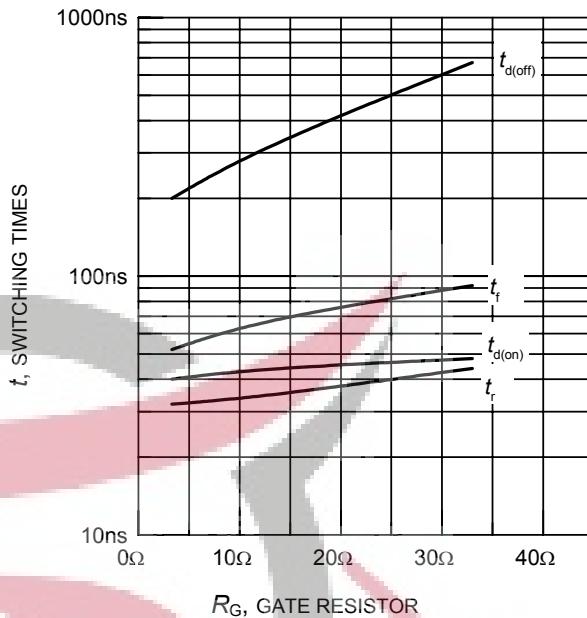
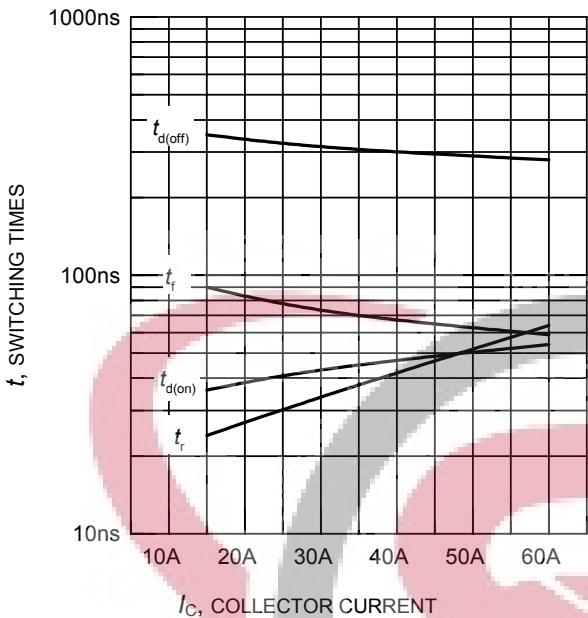
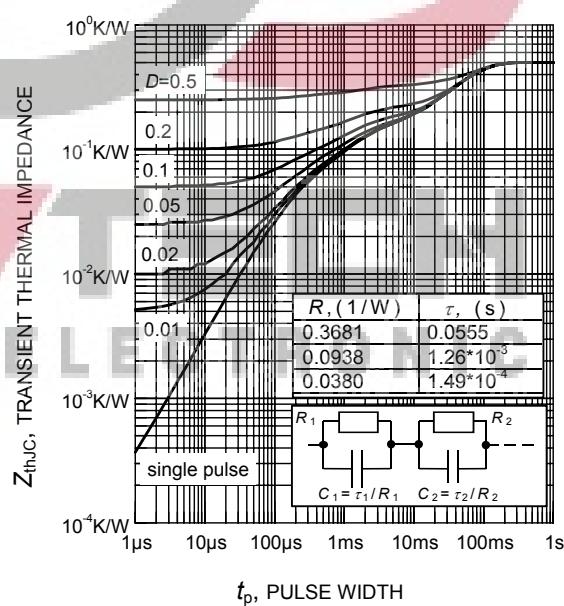
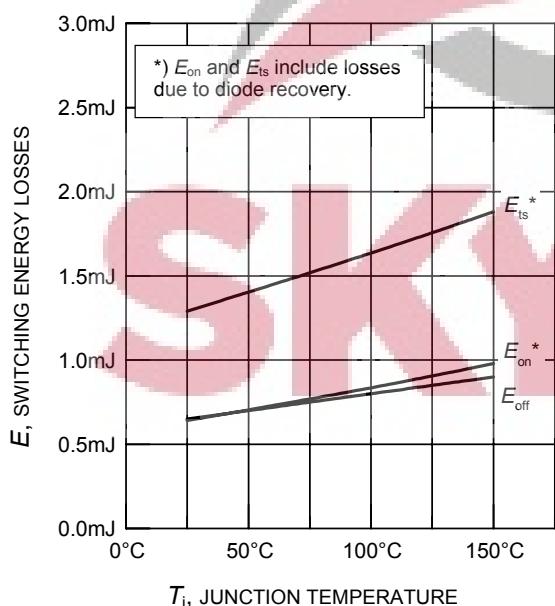
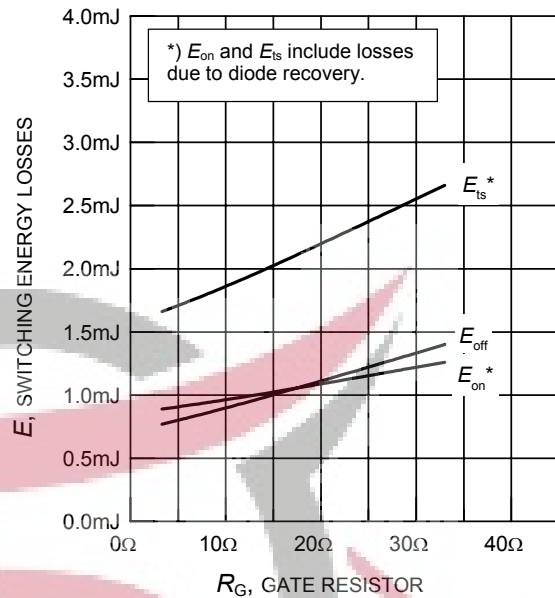
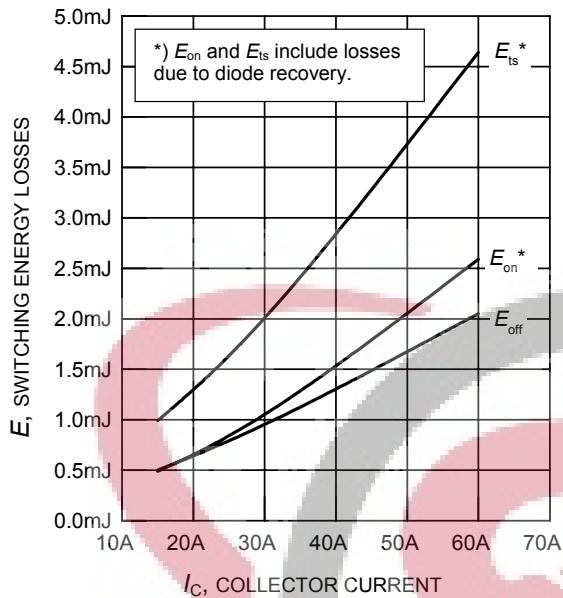


Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature
($V_{GE} = 15\text{V}$)





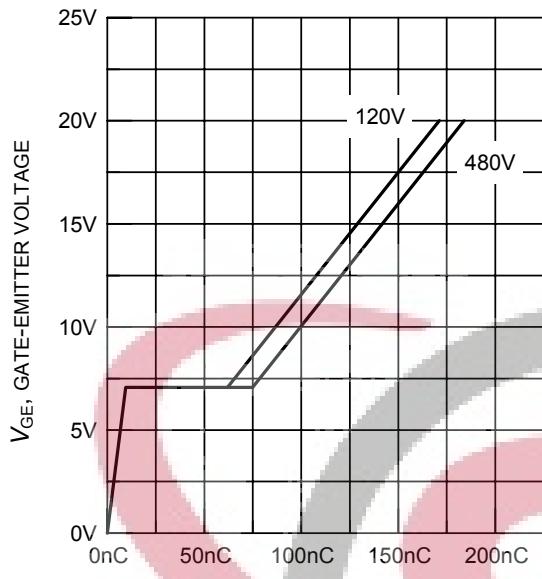


Figure 17. Typical gate charge
($I_C = 30A$)

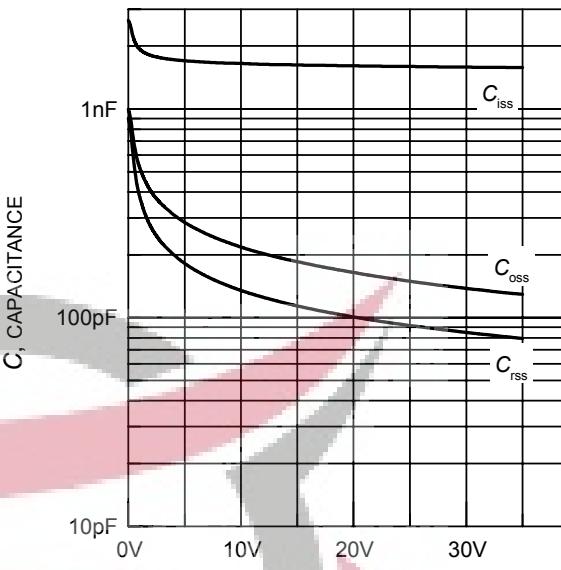


Figure 18. Typical capacitance as a function of collector-emitter voltage
($V_{GE} = 0V, f = 1MHz$)

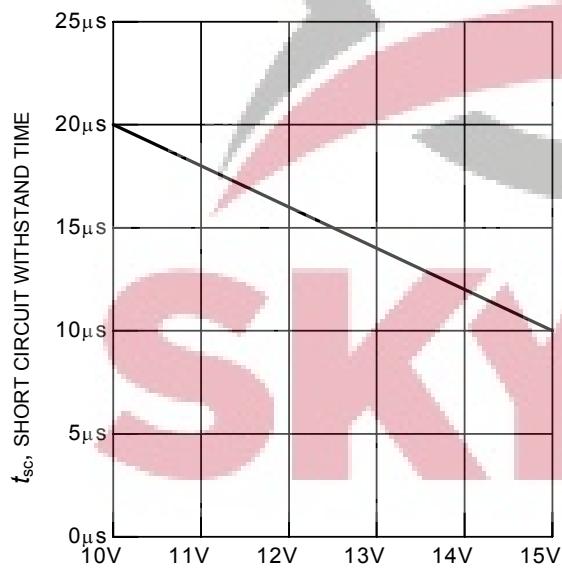


Figure 19. Short circuit withstand time as a function of gate-emitter voltage
($V_{CE} = 600V$, start at $T_j = 25^{\circ}C$)

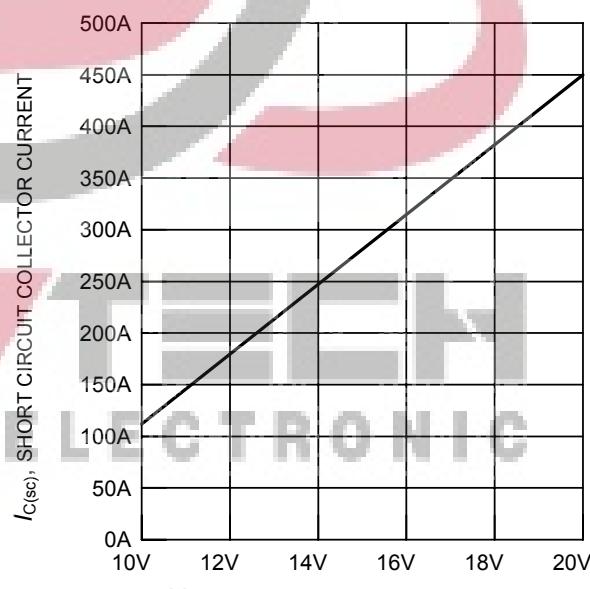
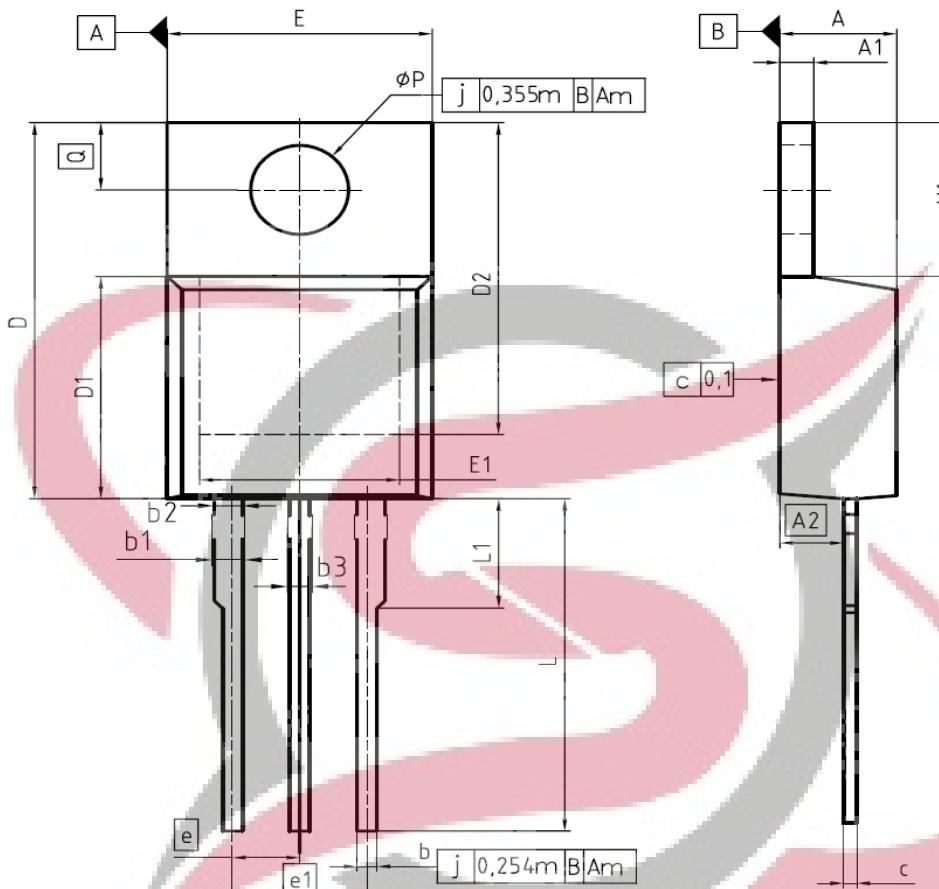


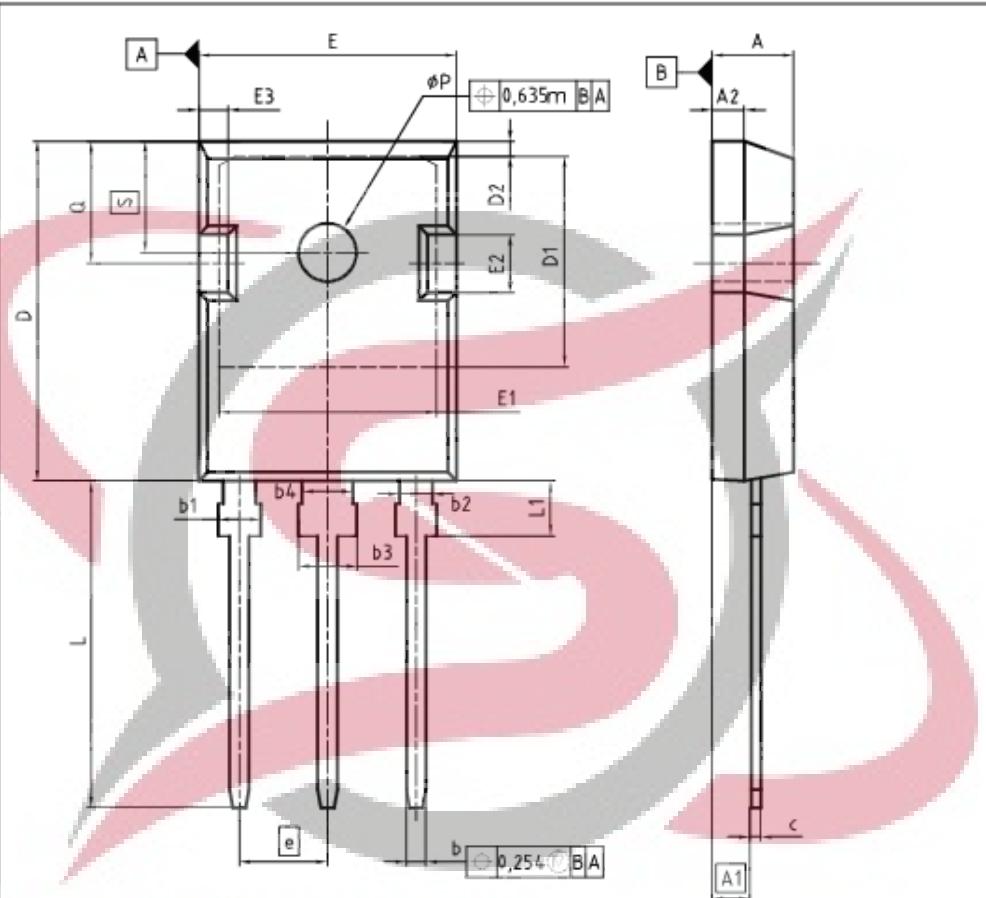
Figure 20. Typical short circuit collector current as a function of gate-emitter voltage
($V_{CE} \leq 600V, T_j = 150^{\circ}C$)

PG-TO-220-3-1


| DIM | MILLIMETERS | | INCHES | |
|----------|-------------|-------|--------|-------|
| | MIN | MAX | MIN | MAX |
| A | 4.30 | 4.57 | 0,169 | 0,180 |
| A1 | 1.17 | 1.40 | 0,046 | 0,055 |
| A2 | 2.15 | 2.72 | 0,085 | 0,107 |
| b | 0.65 | 0.86 | 0,026 | 0,034 |
| b1 | 0.95 | 1.40 | 0,037 | 0,055 |
| b2 | 0.95 | 1.15 | 0,037 | 0,045 |
| b3 | 0.65 | 1.15 | 0,026 | 0,045 |
| c | 0.33 | 0.60 | 0,013 | 0,024 |
| D | 14.81 | 15.95 | 0,583 | 0,628 |
| D1 | 8.51 | 9.45 | 0,335 | 0,372 |
| D2 | 12.19 | 13.10 | 0,480 | 0,516 |
| E | 9.70 | 10.36 | 0,382 | 0,408 |
| E1 | 6.50 | 8.60 | 0,256 | 0,339 |
| e | 2.54 | | 0.100 | |
| e1 | 5.08 | | 0.200 | |
| N | 3 | | 3 | |
| H1 | 5.90 | 6.90 | 0.232 | 0.272 |
| L | 13.00 | 14.00 | 0.512 | 0.551 |
| L1 | - | 4.80 | - | 0.189 |
| ϕP | 3.60 | 3.89 | 0.142 | 0.153 |
| Q | 2.60 | 3.00 | 0.102 | 0.118 |

| |
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| 2.5 |
| 0 2.5 |
| 5mm |
| EUROPEAN PROJECTION |
| |
| ISSUE DATE 23-08-2007 |
| REVISION 05 |

T0247-3



| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|-------|--------|-------|
| | MIN | MAX | MIN | MAX |
| A | 4.83 | 5.21 | 0.180 | 0.205 |
| A1 | 2.27 | 2.54 | 0.089 | 0.100 |
| A2 | 1.85 | 2.16 | 0.073 | 0.085 |
| b | 1.07 | 1.33 | 0.042 | 0.052 |
| b1 | 1.90 | 2.41 | 0.075 | 0.095 |
| b2 | 1.90 | 2.16 | 0.075 | 0.085 |
| b3 | 2.87 | 3.58 | 0.113 | 0.133 |
| b4 | 2.87 | 3.13 | 0.113 | 0.123 |
| c | 0.55 | 0.68 | 0.022 | 0.027 |
| D | 20.80 | 21.10 | 0.819 | 0.831 |
| D1 | 16.25 | 17.65 | 0.640 | 0.695 |
| D2 | 0.95 | 1.35 | 0.037 | 0.053 |
| E | 15.70 | 16.13 | 0.618 | 0.635 |
| E1 | 13.10 | 14.15 | 0.516 | 0.557 |
| E2 | 3.68 | 5.10 | 0.145 | 0.201 |
| E3 | 1.00 | 2.60 | 0.039 | 0.102 |
| e | 5.44 | | 0.214 | |
| N | 3 | | 3 | |
| L | 19.80 | 20.32 | 0.780 | 0.800 |
| L1 | 4.10 | 4.47 | 0.161 | 0.176 |
| P | 0.635 | | 0.138 | |
| Q | 5.49 | 6.00 | 0.216 | 0.236 |
| S | 6.04 | 6.30 | 0.238 | 0.248 |

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| 04 | |

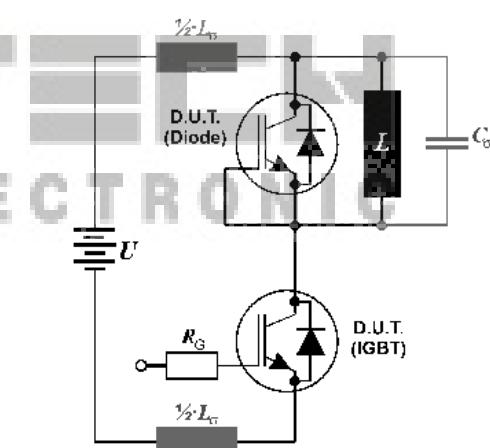
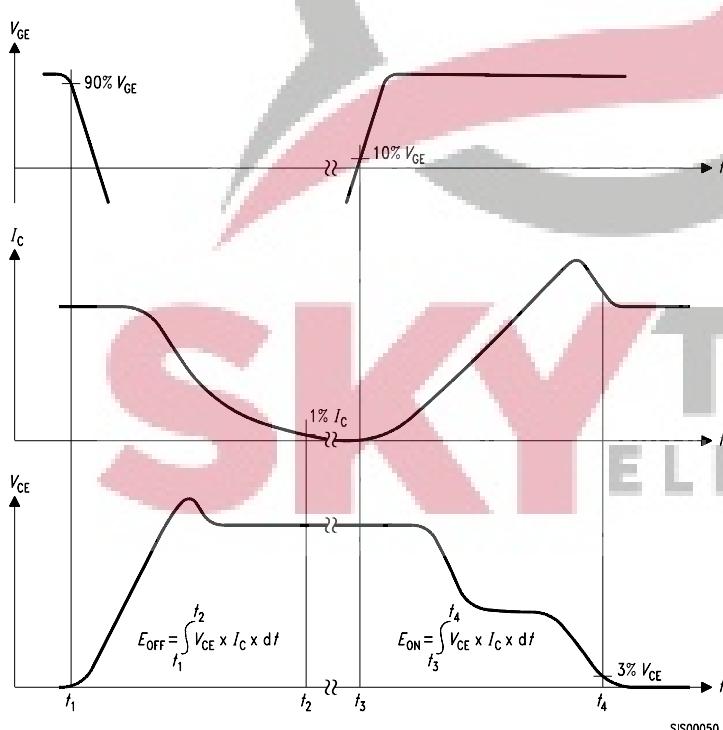
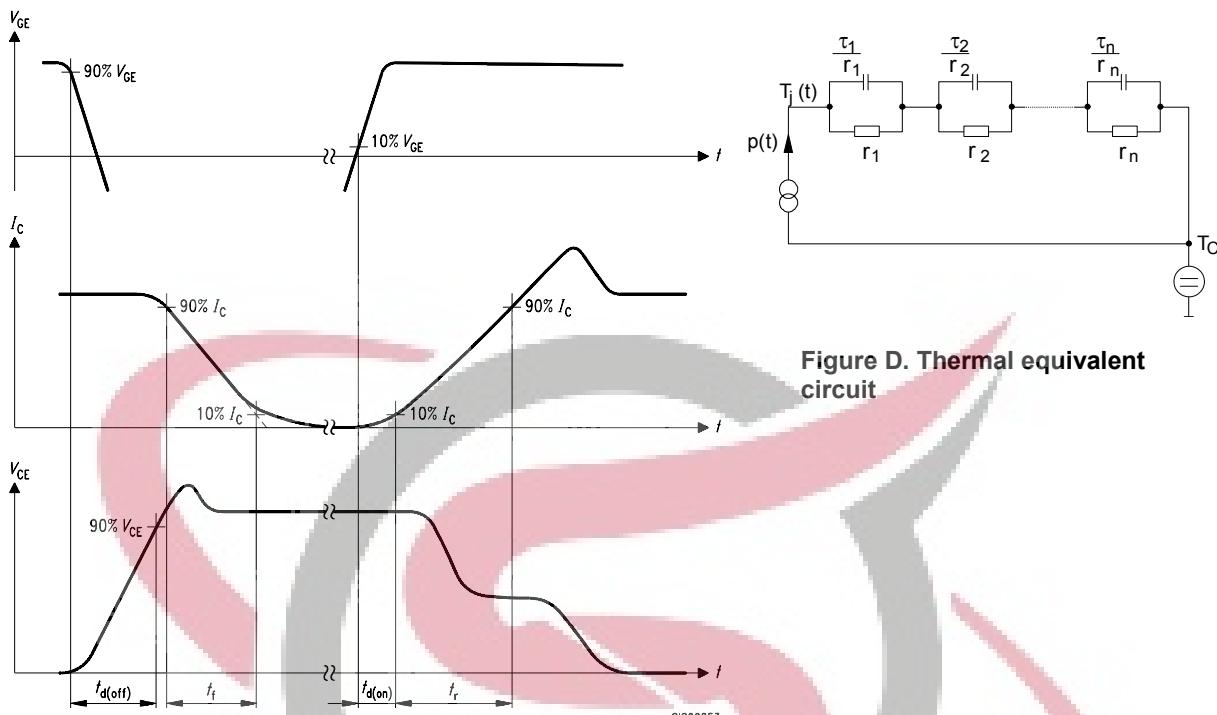


Figure E. Dynamic test circuit
Leakage inductance $L_\sigma = 180\text{nH}$ and Stray capacity $C_\sigma = 900\text{pF}$.

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